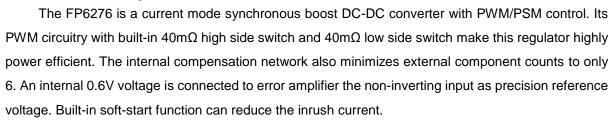




500kHz 6A High Efficiency Synchronous PWM Boost Converter

### **General Description**



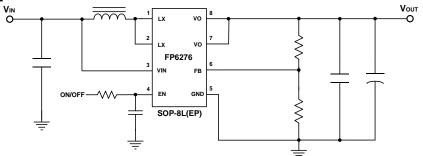
### **Features**

- Current mode with PWM/PSM control
- Input voltage range: 2.4V~4.5V
- ➢ Adjustable Output up to 5.3V
- Shutdown current: <1uA</p>
- Oscillator frequency: 500KHz
- Reference voltage: 0.6V +/-2%
- Disconnect load during shutdown
- Cycle-by-cycle current limit
- > Low  $R_{DS}(on)$ : 40m $\Omega$  for both high and low side.
- Protection: OTP, SCP
- Internal compensation
- Internal soft-start: 7ms
- Package: SOP-8L(EP)

## Applications

- > Chargers
- Handheld Devices
- Portable Products
- Power Bank

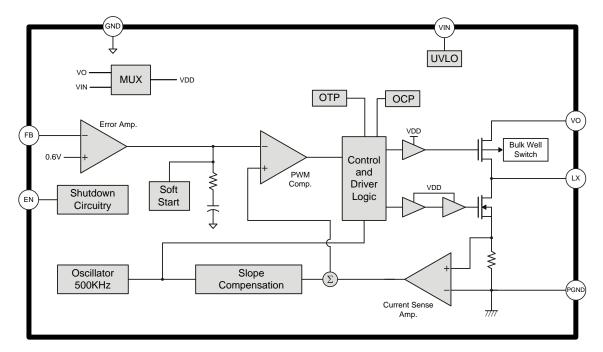
### **Typical Application Circuit**



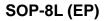


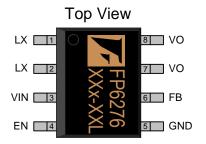
FP6276

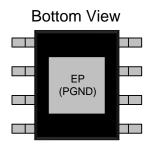
# **Function Block Diagram**



### **Pin Descriptions**







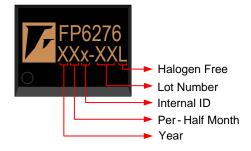
Name	No.	1/0	Description
LX	1	I	Power Switch Output
LX	2	I	Power Switch Output
VIN	3	Р	IC Power Supply
EN	4	I	Enable Control (Active High)
GND	5	Р	IC Ground
FB	6	Ι	Error Amplifier Inverting Input
VO	7	0	Output Voltage Pin
VO	8	0	Output Voltage Pin
PGND	EP	Р	IC Power Ground(Must connect to GND)





### **Marking Information**

#### SOP-8L(EP)



Halogen Free: Halogen free product indicator Lot Number: Wafer lot number's last two digits

For Example  $\rightarrow$  Lot : 123466  $\rightarrow$  XXx-66L

Internal ID: Internal Identification Code

Per-Half Month: Production period indicator in half month time unit

For Example :  $A \rightarrow$  First Half Month of January

- $\mathsf{B} \ \rightarrow \text{Second Half Month of January}$
- $\mathsf{C} \ \rightarrow \text{First Half Month of February}$
- $\mathsf{D} \ \rightarrow \text{Second Half Month of February}$

Year: Production year's last digit





### **Ordering Information**

Part Number	Operating Temperature	Package	MOQ	Description
FP6276XR-G1	-40°C ~ 85°C	SOP-8L(EP)	2500EA	Tape & Reel

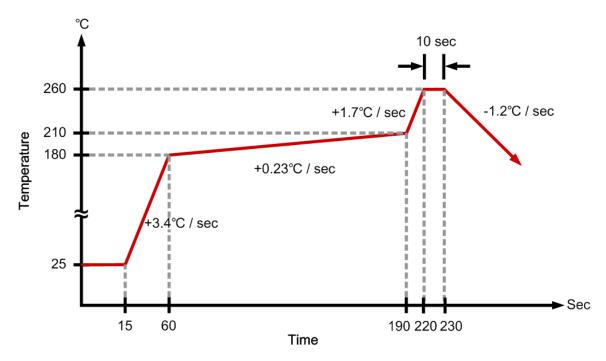
### **Absolute Maximum Ratings**

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply Voltage	V <sub>IN</sub>		0		6	V
LX Voltage	V <sub>LX</sub>		0		7	V
EN,FB,VO Voltage			0		6	V
Thermal Resistance (Note1)	θ <sub>JA</sub>	SOP-8L(EP)			+60	°C / W
Junction Temperature	TJ				+150	°C
Operating Temperature	T <sub>OP</sub>		-40		+85	°C
Storage Temperature	T <sub>ST</sub>		-65		+150	°C
Lead Temperature		(soldering, 10 sec)			+260	°C

#### Note1:

 $\theta_{JA}$  is measured in the natural convection at  $T_A=25^{\circ}C$  on a low effective thermal conductivity test board of JEDEC 51-3 thermal measurement standard.









## **Recommended Operating Conditions**

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply Voltage	Vin		2.4		4.5	V
Operating Temperature Range	T <sub>A</sub>	Ambient Temperature	-40		+85	°C

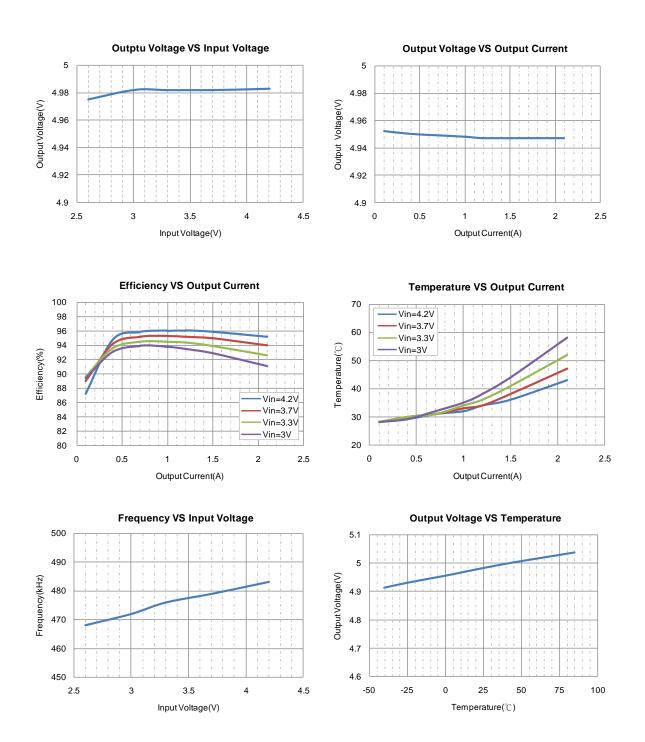
## **DC Electrical Characteristics** (V<sub>IN</sub>=3.3V, T<sub>A</sub>=25°C, unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input Voltage	V <sub>IN</sub>		2.4		4.5	V
Under Voltage Lockout	V <sub>UVLO</sub>			2.1		V
UVLO Hysteresis				0.1		V
Quiescent Current	Icc	V <sub>FB</sub> =0.65V, No switching		280		μA
Average Supply Current	I <sub>CC</sub>	V <sub>FB</sub> =0.55V, Switching		3.6		mA
Shutdown Current	I <sub>CC</sub>	V <sub>EN</sub> =GND		0.1		μA
Linear Charge Current	I <sub>CHARGE</sub>	V <sub>OUT</sub> <v<sub>IN</v<sub>	3			А
Operation Frequency	f <sub>osc</sub>	V <sub>FB</sub> =0.55V		500		kHz
Maximum Duty Ratio	%			90		%
Feedback Voltage	V <sub>REF</sub>	V <sub>IN</sub> =4.5V	0.588	0.6	0.612	V
Enable Voltage	V <sub>EN</sub>		0.96			V
Shutdown Voltage	V <sub>EN</sub>				0.6	V
Soft-Start Time	tss	V <sub>IN</sub> =4.5V		7		ms
High Side Switch R <sub>DS</sub> (ON)	R <sub>ON-PMOS</sub>			40		mΩ
Low Side Switch R <sub>DS</sub> (ON)	R <sub>ON-NMOS</sub>			40		mΩ
Switch Current Limit	I <sub>OCP</sub>			6		А
Thermal Shutdown Threshold	T <sub>OTP</sub>			150		°C
Thermal Shutdown Hysteresis				30		°C



## **Typical Operating Characteristics**

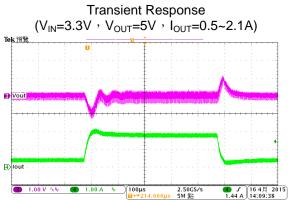
( $V_{CC}$ =3V,Vout=5V,Iout=2.1A,T<sub>A</sub>=25°C, unless otherwise specified)

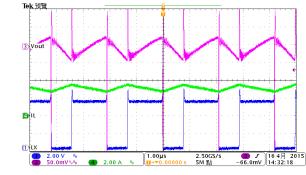


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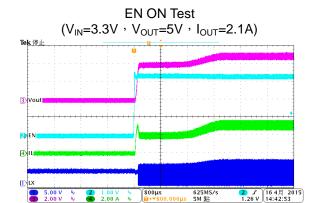


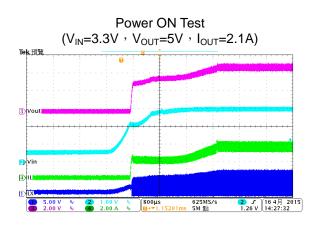


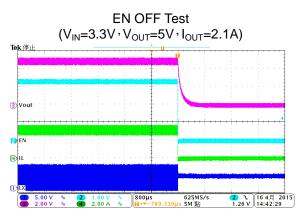


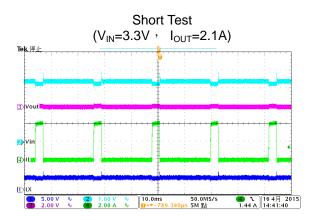
**Output Ripple** 

(V<sub>IN</sub>=3.3V, V<sub>OUT</sub>=5V, I<sub>OUT</sub>=2.1A)











## **Function Description**

#### Operation

The FP6276 is a current mode synchronous boost converter. The constant switching frequency is 500kHz and operates with pulse width modulation (PWM). Build-in  $40m\Omega$  high side switch and  $40m\Omega$  low side switch provides a high efficient conversion.

#### **Soft Start Function**

Soft start circuitry is integrated into FP6276 to avoid inrush current during power on. After the IC is enabled, the output of error amplifier is clamped by the internal soft-start function, which causes PWM pulse width increasing slowly and thus reducing input surge current.

#### **Over Temperature Protection (OTP)**

FP6276 will turn off the power MOSFET automatically when the internal junction temperature is higher than 150°C. The power MOSFET wake up when the junction temperature drops 30°C under the OTP threshold temperature.



## **Application Information**

#### **Inductor Selection**

Inductance value is decided based on different condition. 1.5uH to 4.7µH inductor value is recommended for general application circuit. There are three important inductor specifications, DC resistance, saturation current and core loss. Low DC resistance has better power efficiency. Also, it avoid inductor saturation which will cause circuit system unstable and lower core loss at 500KHz.

#### **Capacitor Selection**

The output capacitor is required to maintain the VO DC voltage. Low ESR capacitors are preferred to reduce the output voltage ripple. Ceramic capacitor of X5R and X7R are recommended, which have low equivalent series resistance (ESR) and wider operation temperature range.

#### **Output Voltage Programming**

The output voltage is set by a resistive voltage divider from the output voltage to FB. The output voltage is:

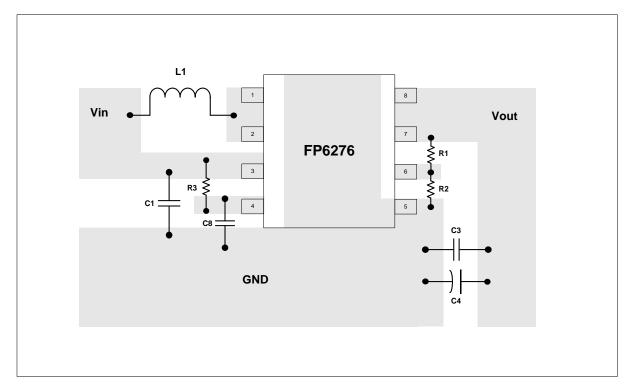
$$V_{OUT} = 0.6V \left(1 + \frac{R1}{R2}\right)$$

#### **Layout Considerations**

- 1. The power traces, consisting of the GND trace, the LX trace and the V<sub>IN</sub> trace should be kept short, direct and wide.
- 2. Layout LX switching node wide and short trace to reduce EMI.
- 3. Place C1 near VIN pin as closely as possible to maintain input voltage steady and filter out the pulsing input current.
- 4. The resistive divider R1 and R2 must be connected to FB pin directly and as closely as possible.
- 5. FB is a sensitive node. Please keep it away from switching node LX.
- 6. The GND of the IC, C1, C3 and C4 should be connected close together directly to a power ground plane.

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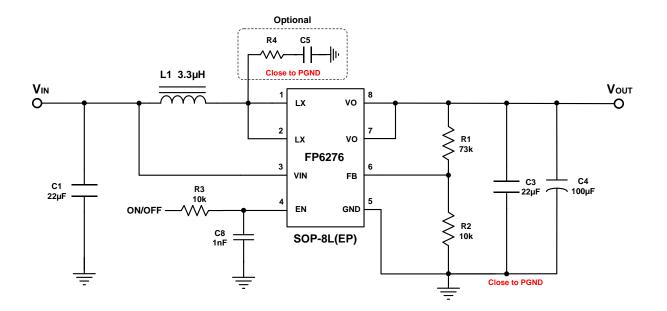
Suggested Layout

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**FP6276** 



# **Typical Application**



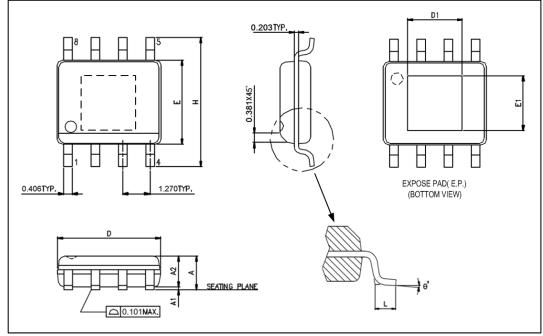
#### Note:

- 1. Use ceramic capacitor of X5R or X7R for C1 and C3.
- 2. R4 and C5 are added for reducing EMI (Electromagnetic Interference).
- 3. EN voltage must be less than or equal to VIN voltage.



## Package Outline

### SOP-8L (EP)



Unit: mm

Symbols	Min. (mm)	Max. (mm)
А	1.346	1.752
A1	0.050	0.152
A2		1.498
D	4.800	4.978
E	3.810	3.987
Н	5.791	6.197
L	0.406	1.270
θ°	0°	8°

#### Exposed PAD Dimensions:

Symbols	Min. (mm)	Max. (mm)	
D1	3.302 REF		
E1	2.413 REF		

#### Note:

- 1. Package dimensions are in compliance with JEDEC outline: MS-012 AA.
- 2. Dimension "D" does not include molding flash, protrusions or gate burrs.
- 3. Dimension "E" does not include inter-lead flash or protrusions.

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